

- NOTES:**
1. COMPONENT KEEPIN DIMENSIONS ARE DENOTED AS MAXIMUM
 2. PCB THICKNESS IS 62 mil (1.57 +/- 0.016 mm)
 3. ALL COMPONENTS SHALL BE UL 94V-0 RECOGNIZED AND ROHS COMPLIANT.
 4. LABEL PLACEMENT (HUMAN READABLE MAC ADDRESSES AND 2x 2D BAR CODES)
10mm FROM BOTTOM EDGE OF PCB
 5. COMPONENT AND TRACE-FREE AREA (TYPICAL TOP AND BOTTOM)

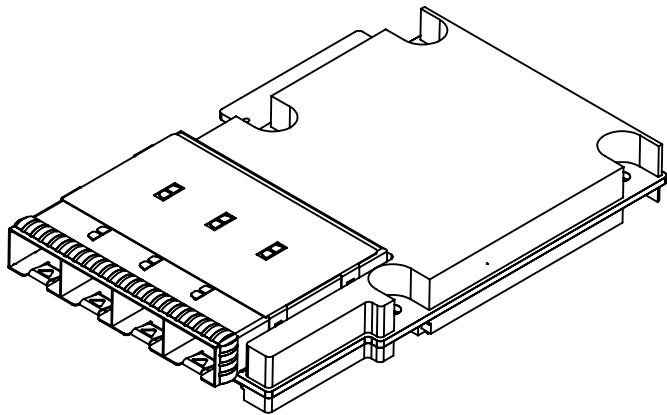
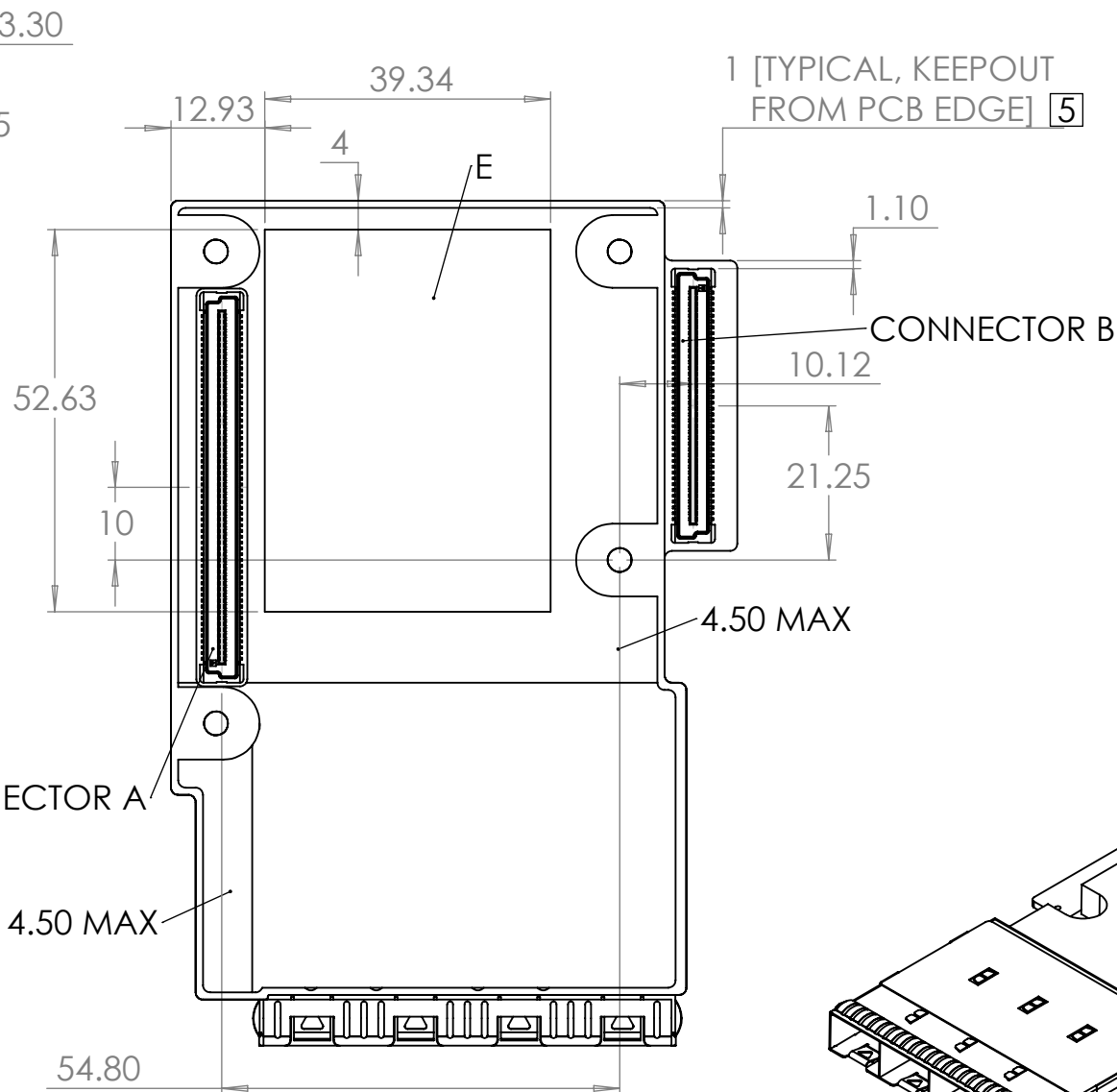
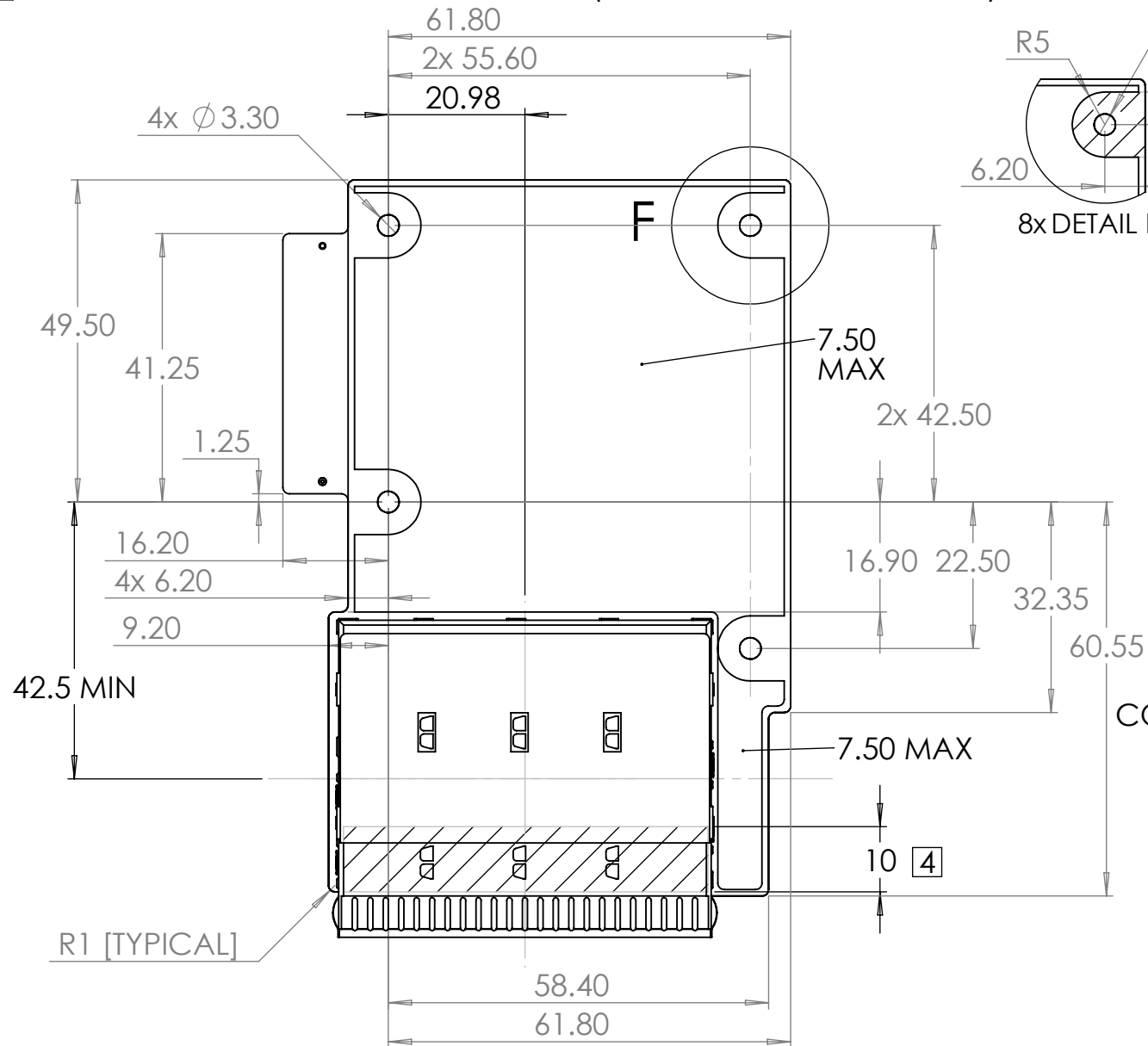
REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
1	INITIAL RELEASE	28JUL14	RLCHU

D

C

B

A



CONNECTOR PN AND HEAT SINK HEIGHT MAX		
	MATING HEIGHT (D=8)	MATING HEIGHT (D=12)
MEZZANINE CONN A	FCI /61083-124402LF	
MEZZANINE CONN B	FCI/ 61082-081402LF	
BASEBOARD CONN A	FCI/61082-121402LF	FCI/61082-122402LF
BASEBOARD CONN B	FCI/61082-081402LF	FCI/61082-082402LF
HEATSINK HEIGHT (E)	7.5mm	11.5mm

DRAWN		NAME	DATE	facebook	
CHECKED		SMILLS	26JUL14		
ENG APPR.		RLCHU	28JUL14		
UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN MILLIMETERS ONE PLACE DECIMAL ± 0.1 TWO PLACE DECIMAL ± 0.01 INTERPRET DIMENSIONS AND TOLERANCES PER: ASME Y14.5M-1994				TITLE:	
PROPRIETARY AND CONFIDENTIAL THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF FACEBOOK. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF FACEBOOK IS PROHIBITED.				OCP MEZZ 2.0 4x SFP+	
SIZE		SPECIFICATION		REV	
B				1	
SCALE: 1:1		WEIGHT:		SHEET 1 OF 1	